



## 40V N-Channel Trench Power MOSFET

### General Description

The SJD40N022 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a wide variety of applications.

### Features

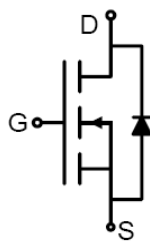
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handling capability
- Lead free product is acquired

### Application

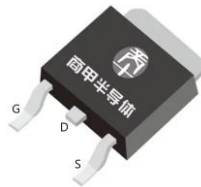
- Load switch
- Uninterruptible power supply
- Hard switched and high frequency circuits

### Key Performance Parameters

| Parameter         | Value | Unit       |
|-------------------|-------|------------|
| $V_{DS}$          | 40    | V          |
| $R_{DS(ON\_TYP)}$ | 2.8   | m $\Omega$ |
| $I_D$             | 130   | A          |
| $Q_G$             | 112   | nC         |



Schematic Diagram



TO-252(DPAK) top view



### Package Marking and Ordering Information

| Device/Ordering Code | Marking   | Package | Packing | Reel Size | Tape width | Quantity |
|----------------------|-----------|---------|---------|-----------|------------|----------|
| SJD40N022            | SJD40N022 | TO-252  | Tape    | \         | \          | 2500 Pcs |

Table 1. Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$  unless otherwise noted)

| Symbol           | Parameter  | Limit      | Unit             |
|------------------|--|------------|------------------|
| $V_{DS}$         | Drain-Source Voltage ( $V_{GS}=0V$ )                 | 40         | V                |
| $V_{GS}$         | Gate-Source Voltage ( $V_{DS}=0V$ )                  | $\pm 20$   | V                |
| $I_D$            | Drain Current-Continuous( $T_C=25^\circ\text{C}$ )   | 130        | A                |
|                  | Drain Current-Continuous( $T_C=100^\circ\text{C}$ )  | 82         | A                |
| $I_{DM}$ (pluse) | Drain Current-Continuous@ Current-Pulsed (Note 1)    | 520        | A                |
| $P_D$            | Maximum Power Dissipation( $T_C=25^\circ\text{C}$ )  | 96         | W                |
|                  | Maximum Power Dissipation( $T_C=100^\circ\text{C}$ ) | 38         | W                |
| $E_{AS}$         | Avalanche energy (Note 2)                            | 576        | mJ               |
| $T_J, T_{STG}$   | Operating Junction and Storage Temperature Range     | -55 To 150 | $^\circ\text{C}$ |

Table 2. Thermal Characteristic

| Symbol          | Parameter                            | Typ | Max | Unit               |
|-----------------|--------------------------------------|-----|-----|--------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case |     | 1.3 | $^\circ\text{C/W}$ |



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**Table 3. Electrical Characteristics ( $T_J=25^{\circ}\text{C}$  unless otherwise noted)**

| Symbol                             | Parameter                         | Conditions   | Min | Typ  | Max  | Unit |
|------------------------------------|-----------------------------------|--|-----|------|------|------|
| On/Off States                      |                                   |  |     |      |      |      |
| BV <sub>DSS</sub>                  | Drain-Source Breakdown Voltage    | V <sub>GS</sub> =0V I <sub>D</sub> =250μA  | 40  |      |      | V    |
| I <sub>DSS</sub>                   | Zero Gate Voltage Drain Current   | V <sub>DS</sub> =40V, V <sub>GS</sub> =0V T <sub>J</sub> =25℃                        |     |      | 1    | μA   |
|                                    |                                   | V <sub>DS</sub> =40V, V <sub>GS</sub> =0V T <sub>J</sub> =125℃                       |     |      | 100  | μA   |
| I <sub>GSS</sub>                   | Gate-Body Leakage Current         | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V   |     |      | ±100 | nA   |
| V <sub>GS(th)</sub>                | Gate Threshold Voltage            | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA                             | 1.0 |      | 2.5  | V    |
| g <sub>FS</sub>                    | Forward Transconductance          | V <sub>DS</sub> =5V, I <sub>D</sub> =20A   |     | 38   |      | S    |
| R <sub>DS(ON)</sub>                | Drain-Source On-State Resistance  | V <sub>GS</sub> =10V, I <sub>D</sub> =20A T <sub>J</sub> =25℃                        |     | 2.8  | 3.4  | mΩ   |
|                                    |                                   | V <sub>GS</sub> =4.5V, I <sub>D</sub> =20A T <sub>J</sub> =25℃                       |     | 4.1  | 5.5  | mΩ   |
| Dynamic Characteristics            |                                   |  |     |      |      |      |
| C <sub>iSS</sub>                   | Input Capacitance                 | V <sub>DS</sub> =20V, V <sub>GS</sub> =0V, f=1.0MHz                                  |     | 6460 |      | pF   |
| C <sub>oss</sub>                   | Output Capacitance                |  |     | 455  |      | pF   |
| C <sub>rSS</sub>                   | Reverse Transfer Capacitance      |  |     | 276  |      | pF   |
| R <sub>g</sub>                     | Gate resistance                   | V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1.0MHz                                   |     | 0.67 |      | Ω    |
| Switching Parameters               |                                   |  |     |      |      |      |
| t <sub>d(on)</sub>                 | Turn-on Delay Time                | V <sub>GS</sub> =10V, V <sub>DS</sub> =20V, R <sub>L</sub> =1Ω, R <sub>GEN</sub> =3Ω |     | 18   |      | nS   |
| t <sub>r</sub>                     | Turn-on Rise Time                 |  |     | 4.4  |      | nS   |
| t <sub>d(off)</sub>                | Turn-Off Delay Time               |  |     | 67   |      | nS   |
| t <sub>f</sub>                     | Turn-Off Fall Time                |  |     | 9.5  |      | nS   |
| Q <sub>g</sub>                     | Total Gate Charge                 | V <sub>GS</sub> =10V, V <sub>DS</sub> =20V, I <sub>D</sub> =20A                      |     | 112  |      | nC   |
| Q <sub>gs</sub>                    | Gate-Source Charge                |  |     | 16.7 |      | nC   |
| Q <sub>gd</sub>                    | Gate-Drain Charge                 |  |     | 26.5 |      | nC   |
| Source-Drain Diode Characteristics |                                   |  |     |      |      |      |
| I <sub>SD</sub>                    | Source-Drain Current (Body Diode) |  |     |      | 130  | A    |
| V <sub>SD</sub>                    | Forward on Voltage (Note 3)       | V <sub>GS</sub> =0V, I <sub>S</sub> =20A   |     |      | 1.2  | V    |
| t <sub>rr</sub>                    | Reverse Recovery Time             | I <sub>F</sub> =20A, dI/dt=500A/μs   |     | 6    |      | ns   |
| Q <sub>rr</sub>                    | Reverse Recovery Charge           | I <sub>F</sub> =20A, dI/dt=500A/μs   |     | 14   |      | nC   |

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

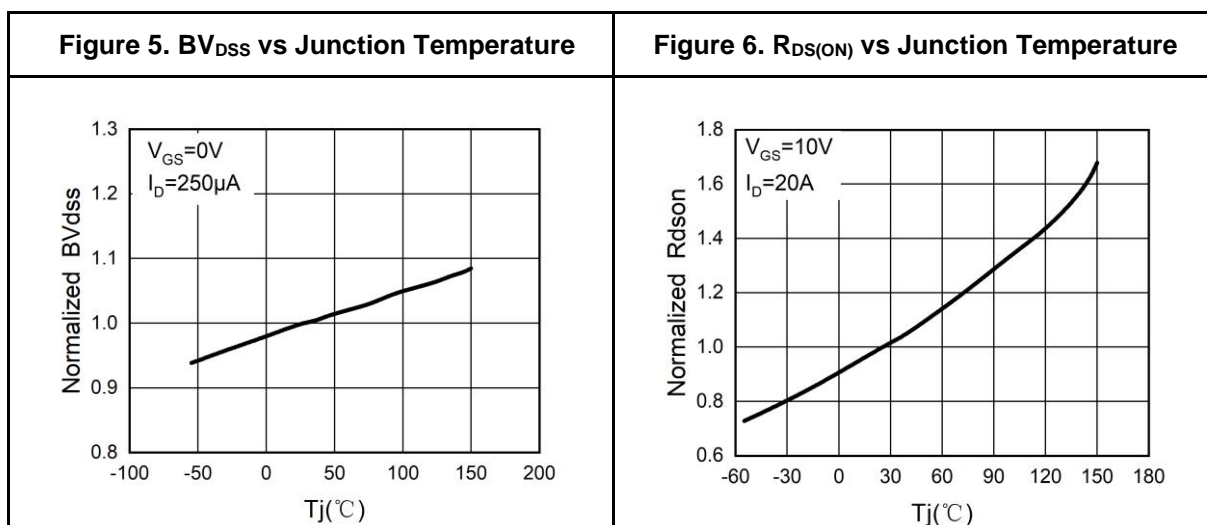
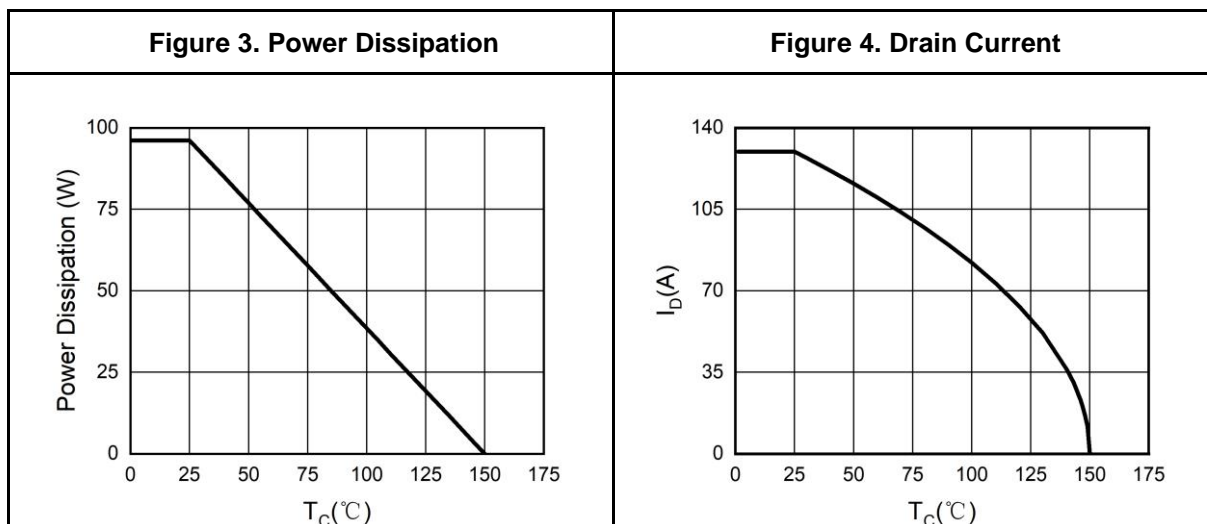
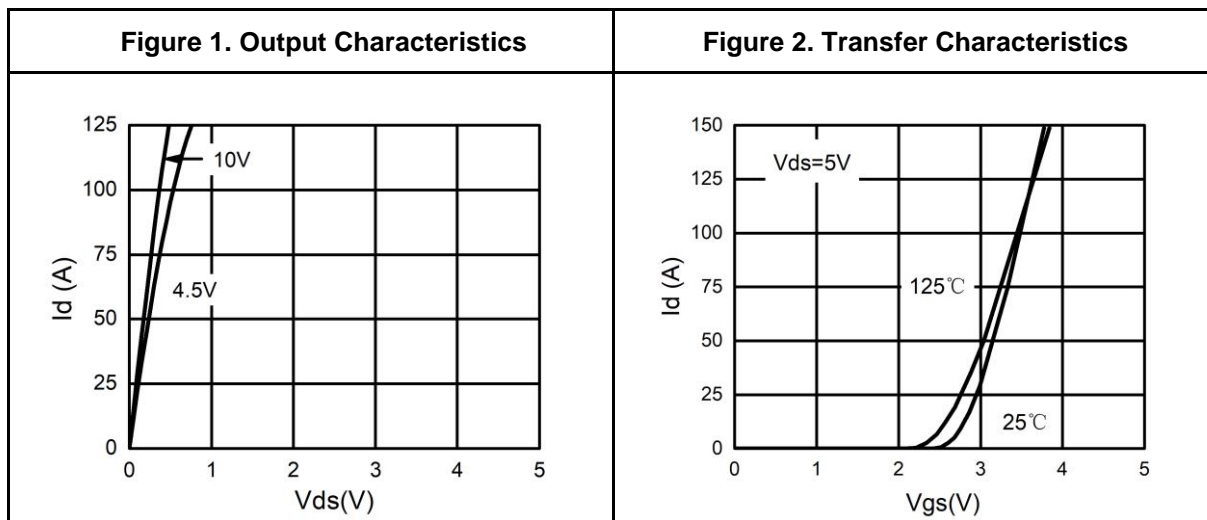
Notes 2.EAS condition:  $T_J=25^{\circ}\text{C}, V_{DD}=40V, V_G=10V, R_g=25\Omega, L=0.5\text{mH}$ .

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



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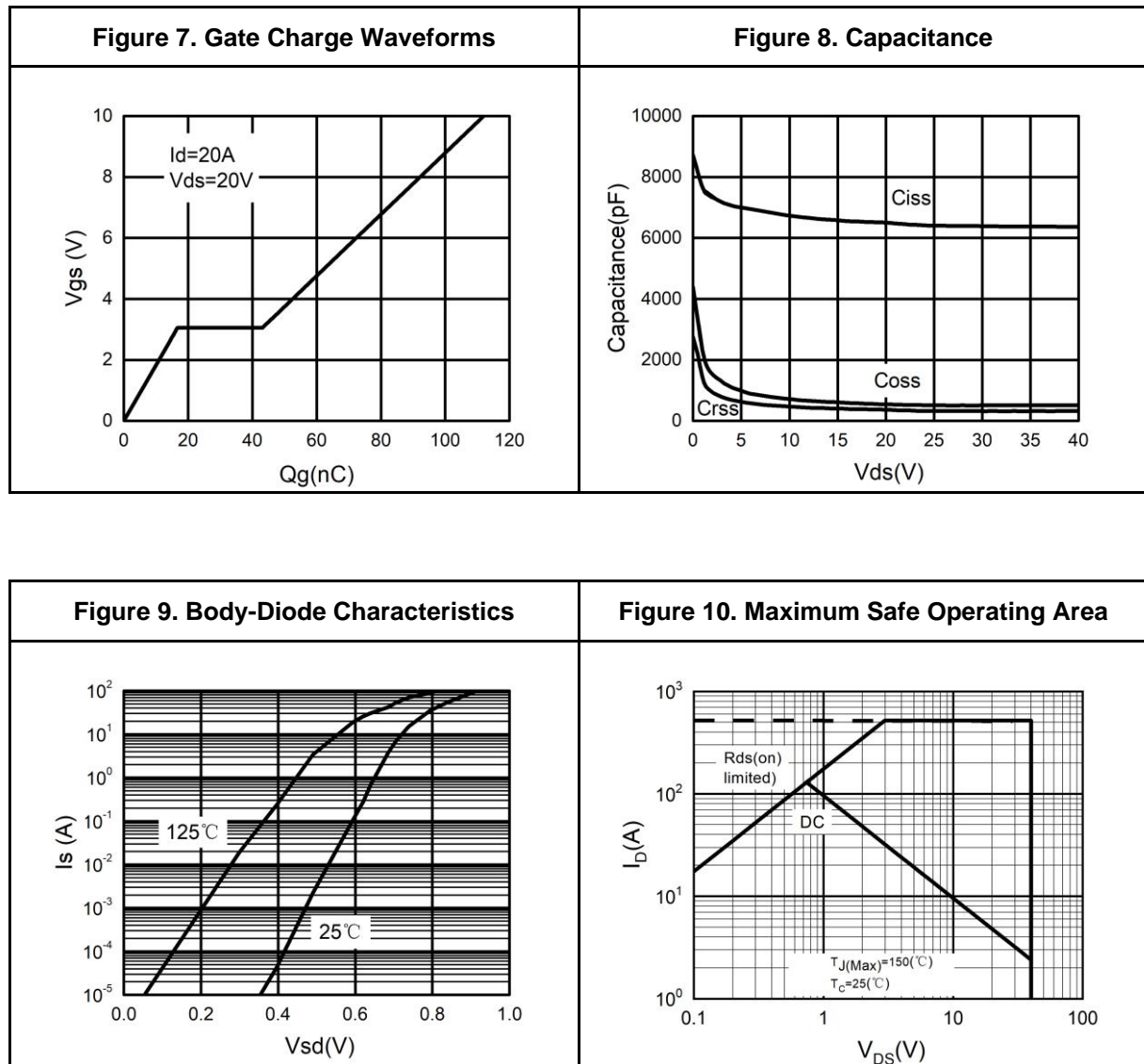
### Typical Electrical And Thermal Characteristics (Curves)





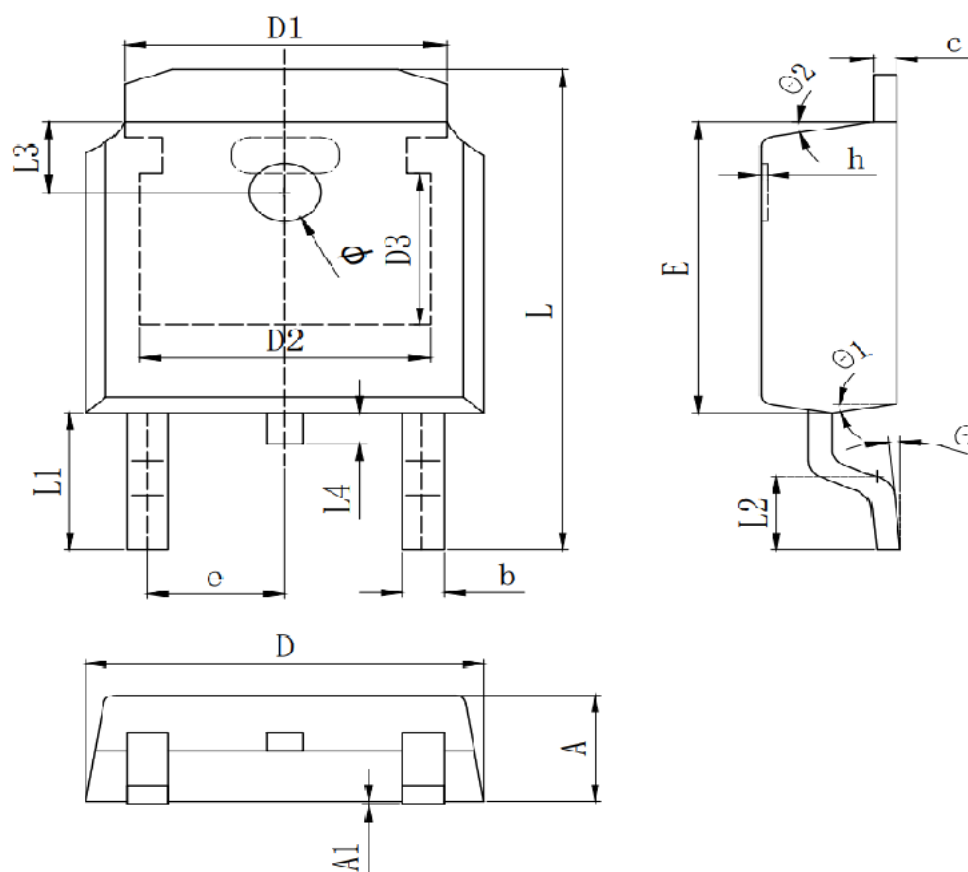
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### Typical Electrical And Thermal Characteristics (Curves)





## TO-252 Package Information



| Symbol | Dimensions In Millimeters |        |        |
|--------|---------------------------|--------|--------|
|        | Min.                      | Typ.   | Max.   |
| A      | 2.200                     | 2.300  | 2.400  |
| A1     | 0.000                     |        | 0.127  |
| b      | 0.640                     | 0.690  | 0.740  |
| c(电镀后) | 0.460                     | 0.520  | 0.580  |
| D      | 6.500                     | 6.600  | 6.700  |
| D1     | 5.334 REF                 |        |        |
| D2     | 4.826 REF                 |        |        |
| D3     | 3.166 REF                 |        |        |
| E      | 6.000                     | 6.100  | 6.200  |
| e      | 2.286 TYP                 |        |        |
| h      | 0.000                     | 0.100  | 0.200  |
| L      | 9.900                     | 10.100 | 10.300 |
| L1     | 2.888 REF                 |        |        |
| L2     | 1.400                     | 1.550  | 1.700  |
| L3     | 1.600 REF                 |        |        |
| L4     | 0.600                     | 0.800  | 1.000  |
| Φ      | 1.100                     | 1.200  | 1.300  |
| θ      | 0°                        |        | 8°     |
| θ1     | 9° TYP                    |        |        |
| θ2     | 9° TYP                    |        |        |



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